

HM25P15-VB Datasheet

P-Channel 150 V (D-S) MOSFET

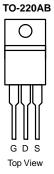
PRODUCT	PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	A) Q _g (Typ.)		
- 150	0.100 at V_{GS} = - 10 V	- 20	13.7		
- 150	0.120 at V_{GS} = - 4.5 V	- 18	13.7		

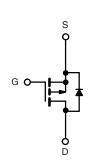
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_{C} = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 150	M	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current ($T_1 = 150 \text{ °C}$)	T _C = 25 °C	1-	- 20		
Continuous Drain Current (1) = 150°C)	T _C = 70 °C	- I _D	- 16		
Pulsed Drain Current		I _{DM}	- 60	A	
Avalanche Current		I _{AS}	- 18		
Single Avalanche Energy ^a L = 0.1 mH		E _{AS}	17.2	mJ	
	T _C = 25 °C	P	37.1 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	0/11	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



COMPLIANT HALOGEN FREE

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		·				
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_D = -250 \mu A$	- 150			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 150 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA
		$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$			- 250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 20			А
	B	V _{GS} = - 10 V, I _D = - 5.0A		0.100		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.0 A		0.120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 5.0 A		12		S
Dynamic ^b						
Input Capacitance	C _{iss}			1055		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 75 V, f = 1 MHz		65		
Reverse Transfer Capacitance	C _{rss}			41		
Total Gate Charge ^c	Q _q	$V_{DS} = -75V, V_{GS} = -10V, I_{D} = -5.0A$		23.2	34.8	nC
Iotal Gale Charge	Чg			13.7	19.6	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 75 V, V_{GS} = - 4.5 V, I_{D} = - 5.0 A		4.5		
Gate-Drain Charge ^c	Q _{gd}			5.8		
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω
Turn-On Delay Time ^c	t _{d(on)}			7	14	
Rise Time ^c	t _r	V_{DD} = - 75 V, R_L = 17.2 Ω		12	18	ns
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50	115
Fall Time ^c	t _f]		9	18	
Drain-Source Body Diode Ratings and	nd Characteri	stics T _C = 25 °C ^b				
Continuous Current	ا _S				- 8.8	•
Pulsed Current	I _{SM}				- 15	A
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V
Reverse Recovery Time	t _{rr}			50	75	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α
Reverse Recovery Charge	Q _{rr}	1		98	147	nC

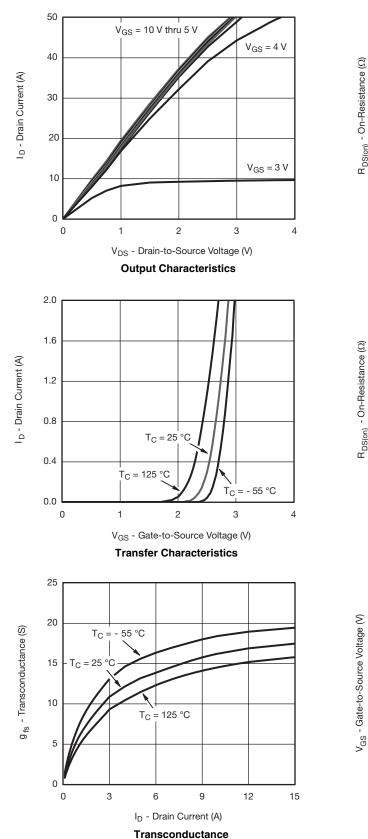
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

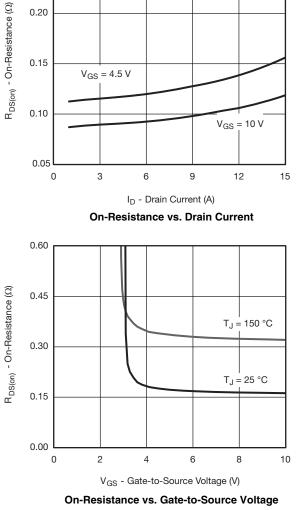
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

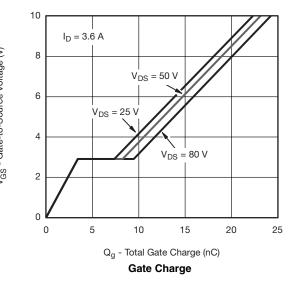




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

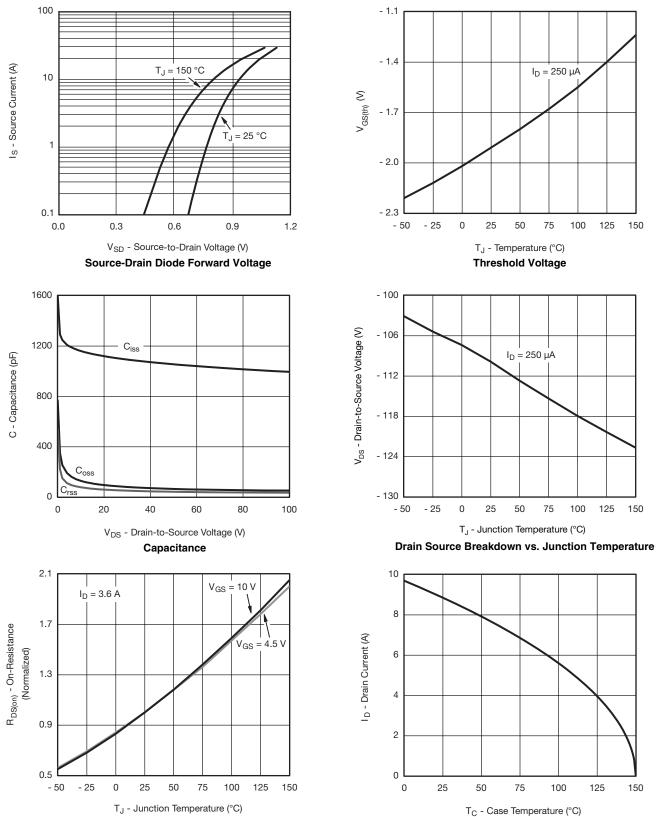


0.25





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

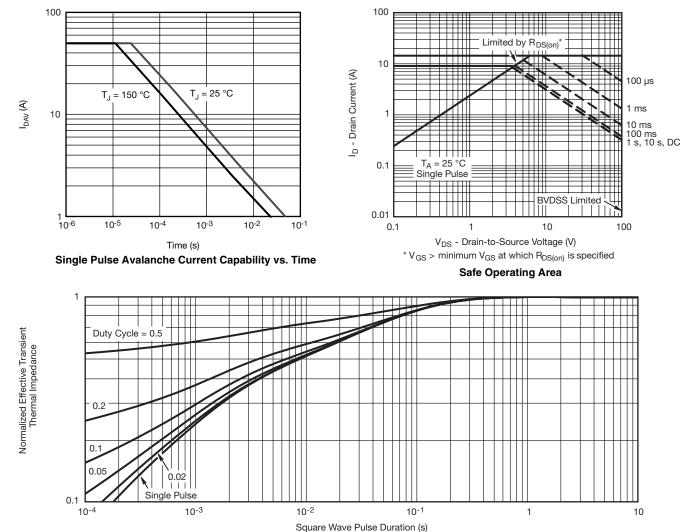


On-Resistance vs. Junction Temperature

Current Derating



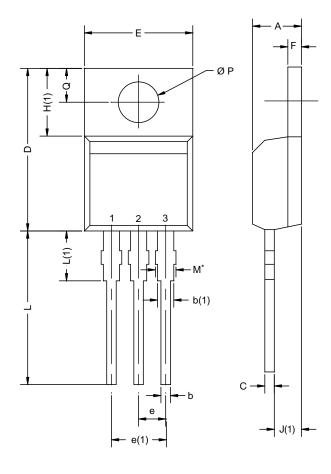
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Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIM	IETERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: X12- DWG: 547	0208-Rev. N,	08-Oct-12		

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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